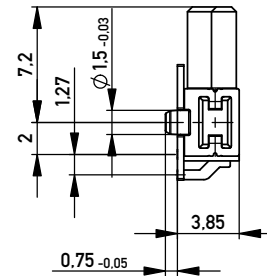
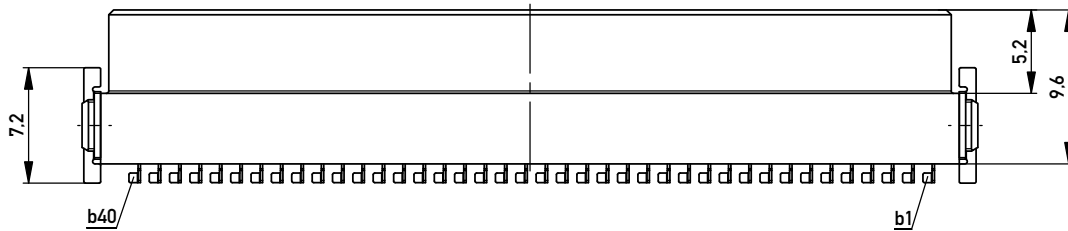
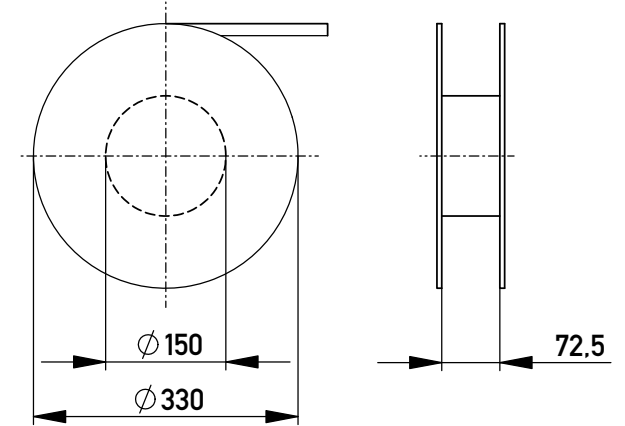
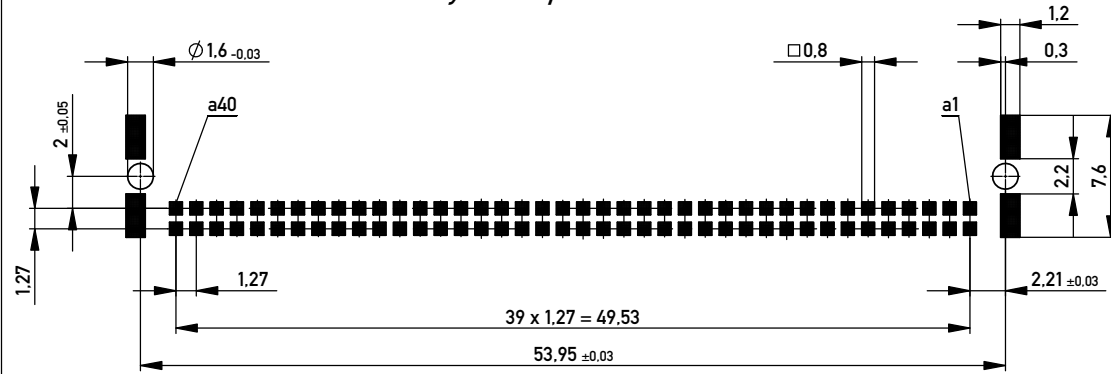
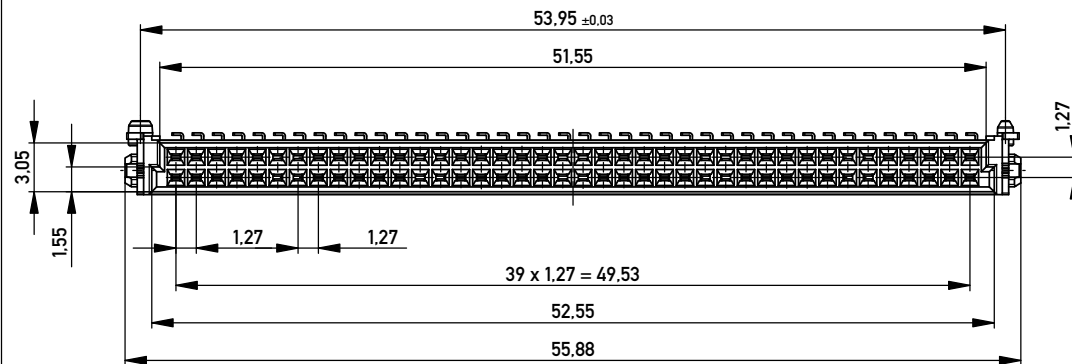
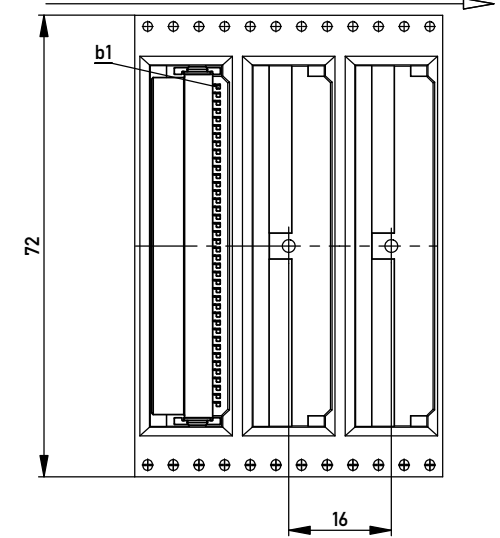


Leiterplatten-Layout Vorschlag für SMT
PCB-Layout Proposal for SMT

Verpackt in Gurtverpackung - *Tape on Reel Packaging*
Verpackungseinheit: 560 Stück - *Packaging unit: 560 pcs*



Abspulrichtung - *Reel off Direction*



Anforderungsstufe 1
Performance Level 1



Kontaktbereich vergoldet
Mating Area gold plating

Anschlussbereich verzinkt 4-6 μm
Terminal Area 4-6 μm tin plating

Koplanarität der Anschlüsse $\leq 0.1 \text{ mm}$
Coplanarity Area of Termination $\leq 0.1 \text{ mm}$

BA7-03 - Standard Bauhöhe

type7-03 - standard assembly height

Information:		Tolerances		Scale	3:1
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Subject to modification without prior notice. Drawing will not be updated.				Federl. SMC-Q 80-SMD-BA7-03 <i>Female SMC-Q 80-SMD-type7-03</i>	
e	04.04.2011	www.ERNI.com		154744	
Index	Date	Class		SMCQ	
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				A3	

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